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CONFIRMATION NO. 4962

SERIAL NUMBER 10/082,867	FILING DATE 02/18/2002 RULE	CLASS 264	GROUP ART UNIT 1731	ATTORNEY DOCKET NO.
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APPLICANTS

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** CONTINUING DATA *****
This appln claims benefit of 60/273,175 02/28/2001
CL 3/24/06

** FOREIGN APPLICATIONS *****
none CL 3/26/06

IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** SMALL ENTITY **
** 03/26/2002

Foreign Priority claimed <input type="checkbox"/> yes <input checked="" type="checkbox"/> no	STATE OR COUNTRY MALAYSIA	SHEETS DRAWING 2	TOTAL CLAIMS 9	INDEPENDENT CLAIMS 3
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35 USC 119 (a-d) conditions met
☐ yes ☒ no ☐ Met after Allowance

Verified and Acknowledged
Examiner's Signature *[Signature]* Initials *[Initials]*

ADDRESS

AIR MAIL

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TITLE
Method of Making Semiconductor Bonding Tools
Ultrasmall semiconductor bonding tools and method of fabrication thereof

FILING FEE RECEIVED 370	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:	<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of time) <input type="checkbox"/> 1.18 Fees (Issue)
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